

Appl. No. 10/696,017  
Amdt. dated Nov. 3, 2005  
Reply to Office action of Aug 4, 2005

### **Remarks**

Applicants thank Examiner Clark again for her patient and careful examination of this application and the clear explanation of the claim rejections; and for conditionally allowing claims 6 and 14. In response, in addition to the previously canceled claims 1-4, applicants cancel additional claims 5-7, 13, 16-20; and amend claim 10, 14, and 15 to overcome the §112, and §103 rejections:

#### **Claim 10:**

Claim 10 is amended to add a substrate element to amend the antecedent defect; and to add a built-up layer element, which includes all the elements in claim 6. As amended, claim 10 is in independent form and includes all the limitations of allowable claim 6 and its base claim 10. Applicants respectfully submit that the amended claim 10 stands patentable.

#### **Claim 14:**

Claim 14 is amended to be in independent form and it includes all of the limitations of the base claims. Applicants respectfully submit that the amended claim 14 stands patentable.

#### **Claim 15:**

Claim 15, as amended, has additional limitation of a step to provide a substrate to overcome the §112 rejection; and a step to form a built-up layer between the substrate and the second bumps to render the bumps co-planar, thus overcomes the §103 rejection because this built-up layer is not disclosed in the cited references. Applicants respectfully submit that the amended claim 15 stands patentable.

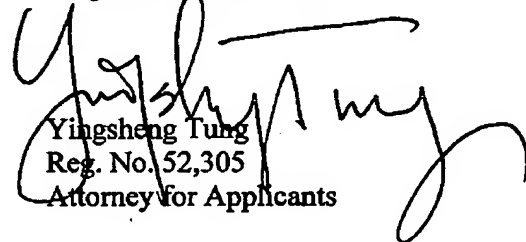
#### **Claims 8, 9, 11, and 12:**

Claims 8, 9, 11, and 12 properly depend from patentable claim 10 and therefore stand patentable at least by virtue of their dependence.

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Applicants respectfully submit that, as amended, this application and the pending claims are in allowable form. Applicants respectfully request timely allowance of the pending claims.

Respectfully submitted,



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